

ABSTRACT OF THE DISCLOSURE

5 A surface acoustic wave device includes a surface
acoustic wave filter element having a piezoelectric
substrate on which comb-like electrodes are formed, and
a package having a first cavity in which the surface
acoustic wave filter is housed. The package includes a
flexible chip mounting base having a first surface on
which the surface acoustic wave filter is mounted and
having a thickness equal to or less than 100 μm .

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